## SKD 115



# SEMIPONT<sup>©</sup> 5

### **Bridge Rectifiers**

#### SKD 115

Target Data

#### Features

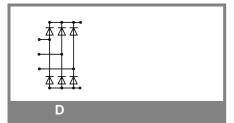
- Compact design
- SKiiP technology: thermal pressure contact, no base plate and no hard mould
- Two screws mounting
- Heat transfer and isolation through direct copper board (low R th)
- Low resistance in steady-state
  and high reliability
- High surge currents
- Up to 1800 V
- UL recognized, file no. E 63 532

#### **Typical Applications**

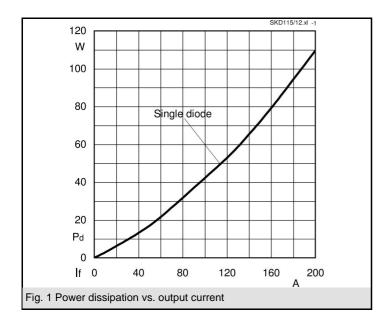
- Three phase rectifiers for power supplies
- Input rectifiers for variable frequency drives
- Rectifiers for DC motor field supplies
- Battery charger rectifiers

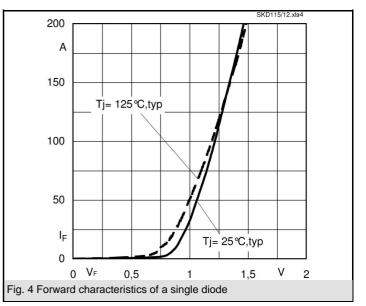
V <sub>RSM</sub> V	V <sub>RRM</sub> , V <sub>DRM</sub> V	I <sub>D</sub> = 110 A (full conduction) (T <sub>s</sub> = 85 °C)
1200	1200	SKD 115/12
1600	1600	SKD 115/16
1800	1800	SKD 115/18

Symbol	Conditions	Values	Units
I <sub>D</sub>	T <sub>s</sub> = 85 °C	110	А
I <sub>FSM</sub>	T <sub>vi</sub> = 25 °C; 10 ms	1200	А
	T <sub>vi</sub> = 125 °C; 10 ms	1150	А
i²t	T <sub>vi</sub> = 25 °C; 8,3 10 ms	7200	A²s
	T <sub>vj</sub> = 125 °C; 8,3 10 ms	6600	A²s
V <sub>F</sub>	T <sub>vi</sub> = 125 °C; I <sub>F</sub> = 75 A	max. 1,25	V
V <sub>(TO)</sub>	T <sub>vi</sub> = 125 °C	max. 0,8	V
r <sub>T</sub>	T <sub>vi</sub> = 125 °C	max. 7	mΩ
I <sub>RD</sub>	$T_{vj} = 25 \text{ °C}; V_{DD} = V_{DRM}; V_{RD} = V_{RRM}$		mA
			mA
R <sub>thjh</sub>	per diode	1	K/W
a gr			K/W
T <sub>solder</sub>	Terminals, max 10s	260	°C
T <sub>vj</sub>		- 40 + 150	°C
T <sub>stg</sub>		- 40 + 125	°C
V <sub>isol</sub>	a. c. 50 Hz; r.m.s.; 1 s / 1 min.	3600 ( 3000 )	V
M <sub>s</sub>	to heatsink; SI units	2,5	Nm
M <sub>t</sub>			Nm
m	approx.	75	g
Case		G 57	

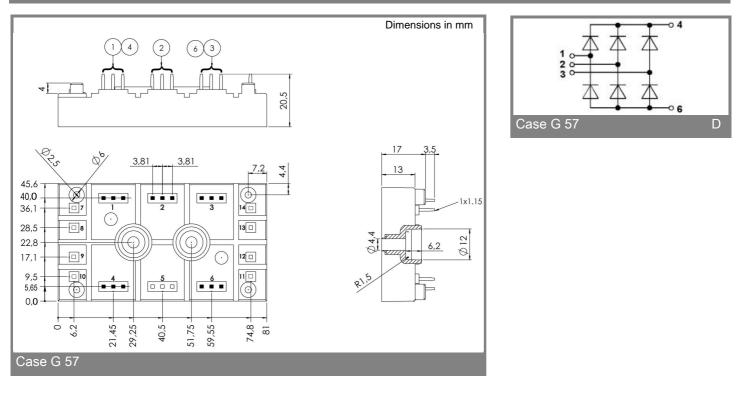


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### **SKD 115**



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